1.10mm Height 1206 Package
Pure Green Chip LED
Technical Data Sheet

Part No.: DL-PCB1206PGC-1PG120



Spec No.: DL-PCB1206PGC-1PG120 Rev No.: V.3 Date: Mar./03/2006 Page: 1 OF 9
HONGKONG DOUBLE LIGHT ELECTRONICS TECHNOLOGY CO.,LIMITED www.doublelight.com.cn

Features:

- 1. Package in 8mm tape on 7" diameter reel.
- 2. Compatible with automatic placement equipment.
- 3. Compatible with infrared and vapor phase reflow solder process.
- 4. Mono-color type.
- 5. The product itself will remain within RoHS compliant Version.

Descriptions:

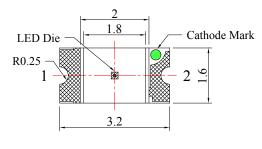
- 1. The 1206 SMD LED is much smaller than lead frame type components, thus enable smaller board size, higher packing. Density, reduced storage space and finally smaller equipment to be obtained.
- 2. Besides, lightweight makes them ideal for miniature applications, etc.

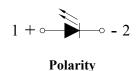
♦ Applications:

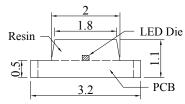
- 1. Automotive: Backlighting in dashboard and switch.
- 2. Telecommunication: Indicator and backlighting in telephone and fax.
- 3. Flat backlight for LCD, switch and symbol.
- 4. General use.

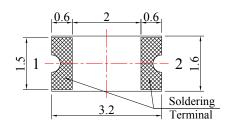
Spec No.: DL-PCB1206PGC-1PG120 Rev No.: V.3 Date: Mar./03/2006 Page: 2 OF 9
HONGKONG DOUBLE LIGHT ELECTRONICS TECHNOLOGY CO.,LIMITED www.doublelight.com.cn

◆ Package Dimension:

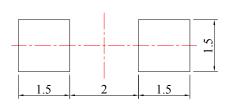








Recommended Soldering Pad Dimensions



Unit: mm Tolerance: ± 0.10mm

- 1. Soldering terminal may shift in x, y direction.
- 2. Polarity referring onto the cathode mark is reversed on the UR/HR/SR.

Part No.	Chip Material	Lens Color	Source Color
DL-PCB1206PGC-1PG120	InGaN	Water Clear	Pure Green

Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ± 0.10mm (.004") unless otherwise specified.
- 3. Specifications are subject to change without notice.

Spec No.: DL-PCB1206PGC-1PG120 Rev No.: V.3
HONGKONG DOUBLE LIGHT ELECTRONICS TECHNOLOGY CO.,LIMITED

Date: Mar./03/2006 Page: 3 OF 9

www.doublelight.com.cn

♦ Absolute Maximum Ratings at Ta=25°C

Parameters	Symbol	Max.	Unit	
Power Dissipation	PD	95	mW	
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	IFP	100	mA	
Continuous Forward Current	IF	25	mA	
Reverse Voltage	VR	5	V	
Electrostatic Discharge	ESD	600	V	
Operating Temperature Range	Topr	-40°C to +80°C		
Storage Temperature Range	Tstg	-40°C to +85°C		
Soldering Temperature	Tsld	260℃ for 5 Seconds		

Electrical Optical Characteristics at Ta=25℃

Parameters	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Luminous Intensity *	IV	300	650		mcd	IF=20mA (Note 1)
Viewing Angle *	2θ1/2		120		Deg	IF=20mA (Note 2)
Peak Emission Wavelength	λр		520		nm	IF=20mA
Dominant Wavelength	λd		525		nm	IF=20mA (Note 3)
Spectral Line Half-Width	Δλ		35		nm	IF=20mA
Forward Voltage	VF	3.00	3.30		V	IF=20mA
Reverse Current	IR			10	μΑ	V _R =5V

Notes:

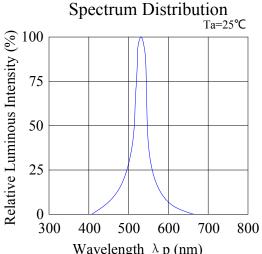
- 1. Luminous Intensity Measurement allowance is ± 10%.
- 2. $\theta_{1/2}$ is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. The dominant wavelength (λ d) is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.

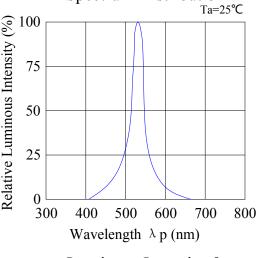
Spec No.: DL-PCB1206PGC-1PG120 Rev No.: V.3 Date: Mar./03/2006 Page: 4 OF 9

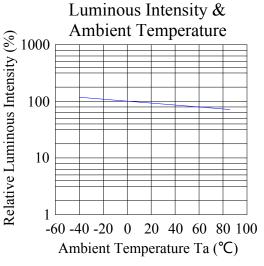
HONGKONG DOUBLE LIGHT ELECTRONICS TECHNOLOGY CO.,LIMITED www.doublelight.com.cn

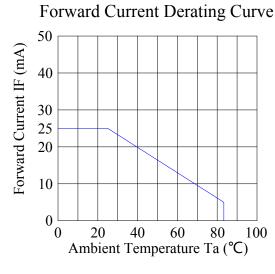
Typical Electrical / Optical Characteristics Curves

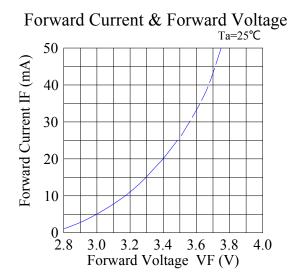
(25°C Ambient Temperature Unless Otherwise Noted)

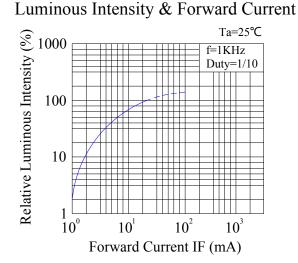


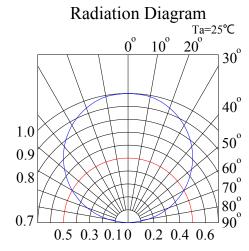












Spec No.: DL-PCB1206PGC-1PG120 Rev No.: V.3 Date: Mar./03/2006 Page: 5 OF 9 HONGKONG DOUBLE LIGHT ELECTRONICS TECHNOLOGY CO., LIMITED www.doublelight.com.cn

• Reliability Test Items and Conditions:

The reliability of products shall be satisfied with items listed below:

Confidence level: 90%.

LTPD: 10%.

1) Test Items and Results:

No.	Test Item	Test Hours/Cycles	Test Conditions	Sample Size	Ac/Re
1	Resistance to Soldering Heat	6 Min	Tsld=260±5℃, Min. 5sec	25pcs	0/1
2	Thermal Shock	300 Cycles	H: +100°C 5min ∫ 10 sec L: -10°C 5min	25pcs	0/1
3	Temperature Cycle	300 Cycles	H: +100 $^{\circ}$ C 15min \int 5min L: -40 $^{\circ}$ C 15min	25pcs	0/1
4	High Temperature Storage	1000Hrs.	Temp: 100℃	25pcs	0/1
5	DC Operating Life	1000Hrs.	IF=20mA	25pcs	0/1
6	Low Temperature Storage	1000Hrs.	Temp: -40˚C	25pcs	0/1
7	High Temperature/ High Humidity	1000Hrs.	85℃/85%RH	25pcs	0/1

2) Criteria for Judging the Damage:

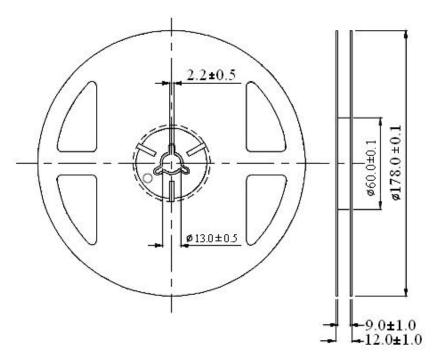
ltem	Symbol	Test Conditions	Criteria for Judgment		
		rest conditions	Min	Max	
Forward Voltage	VF	IF=20mA		F.V.*)×1.1	
Reverse Current	IR	VR=5V		F.V.*)×2.0	
Luminous Intensity	IV	IF=20mA	F.V.*)×0.7		

*) F.V.: First Value.

Spec No.: DL-PCB1206PGC-1PG120 Rev No.: V.3 Date: Mar./03/2006 Page: 6 OF 9

HONGKONG DOUBLE LIGHT ELECTRONICS TECHNOLOGY CO.,LIMITED www.doublelight.com.cn

Reel Dimensions:

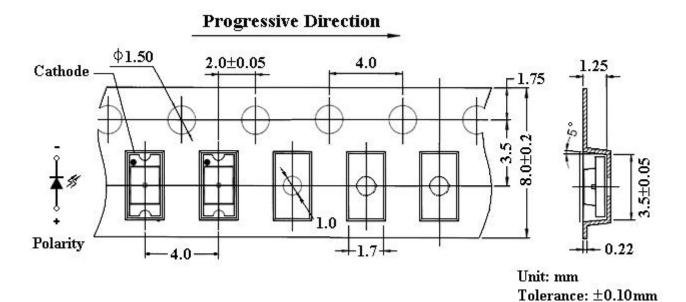


Unit: mm

Tolerance: ± 0.25 mm

Carrier Tape Dimensions:

Loaded quantity 3000 PCS Per reel.



Spec No.: DL-PCB1206PGC-1PG120 Rev No.: V.3 Date: Mar./03/2006 Page: 7 OF 9 HONGKONG DOUBLE LIGHT ELECTRONICS TECHNOLOGY CO.,LIMITED

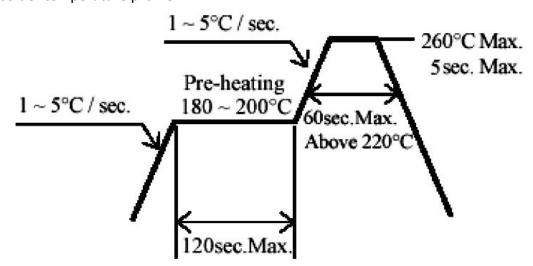
www.doublelight.com.cn

Please read the following notes before using the product:

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
 - 2.1 Do not open moisture proof bag before the products are ready to use.
 - 2.2 Before opening the package, the LEDs should be kept at 30℃ or less and 90%RH or less.
 - 2.3 The LEDs should be used within a year.
 - 2.4 After opening the package, the LEDs should be kept at 30℃ or less and 70%RH or less.
 - 2.5 The LEDs should be used within 168 hours (7 days) after opening the package.
 - 2.6 If the moisture adsorbent material (silica gel) has fabled away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment: $60\pm5^{\circ}$ C for 24 hours.
- 3. Soldering Condition
 - 3.1 Pb-free solder temperature profile.



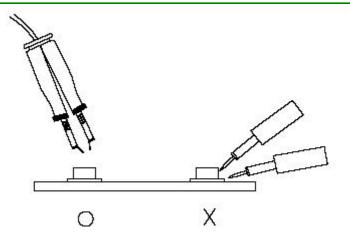
- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.
- 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 260° C for 5 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

Spec No.: DL-PCB1206PGC-1PG120 Rev No.: V.3 Date: Mar./03/2006 Page: 8 OF 9
HONGKONG DOUBLE LIGHT ELECTRONICS TECHNOLOGY CO.,LIMITED www.doublelight.com.cn



6. Caution in ESD

Static Electricity and surge damages the LED. It is recommended to use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.

Spec No.: DL-PCB1206PGC-1PG120 Rev No.: V.3 Date: Mar./03/2006 Page: 9 OF 9
HONGKONG DOUBLE LIGHT ELECTRONICS TECHNOLOGY CO.,LIMITED www.doublelight.com.cn